ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pan-	C. Bannockt	ourn. Illinois. A	Il rights reserved untions.	under both	This docum level parts, t	ent is a declaration er	on of the subs compasses al	tances wi ll lower le	thin the manufacture evel materials for wh	er listed i nich the n	tem. Note: if nanufacturer	the item is an as has engineering	ssembly with lower responsibility.
				Form Type Distribute					als and Mfg Information				
Supplier Information													
Company name*	Company unique ID				Unique ID Authority				Response Date*				
onsemi										2024-05-13			
Contact Name Title -			Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Prod			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title			Title - Representative			Phone - Representative*				Email - Representative*			
Product-Env-Stewards Pr			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	Mai	Manufacturing Site		Weight*	UOM	Unit Type
	ADT747 REEL			I FAN CNTRLR		2024-05-13		PH	PH1		143.27	mg	Each
Manufacturing Proccess Informat	ion												
Terminal Plating / Grid Array Material Terminal Base /		Alloy	J-STD-020 MSL	Rating	Peak Proce	ss Body Tem	perature	Max Time at Peak	Temperat	ture Numb	er of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU A		CU Alloy	lloy 3			<b>260</b> C		1	30		seconds 3		
Comments													
ATTENTION: MSL 3 Rated item requires	Bake and D	ry Pack (after	electrical test)										
for more information regarding material of	omposition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	IS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead , Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl alate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe ve independently verified such information. How heir contributions to the part, and those certifica anditions of that agreement, including any warr	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	In the server of the select the corresponding response in the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.85	mg	Supplier	Silicon (Si)	7440-21-3		4.85	mg
Die Attach	0.31	mg	Supplier	Silver (Ag)	7440-22-4		0.2325	mg
			Supplier	Epoxy resins	129915-35-1		0.0775	mg
Lead Frame 6	61.08	mg	Supplier	Silver (Ag)	7440-22-4		0.6658	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0733	mg
			Supplier	Iron (Fe)	7439-89-6		1.4171	mg
			Supplier	Copper (Cu)	7440-50-8		58.9056	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0183	mg
Mold Compound-Black	73.17	mg		Epoxy Phenol Resin	proprietary data		7.6828	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		65.4871	mg
Plating	3.23	mg	Supplier	Tin (Sn)	7440-31-5		3.23	mg
Wire Bond - Au	0.63	mg	Supplier	Gold (Au)	7440-57-5		0.63	mg